

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Power Dissipation (Note 7)	P _{PK}	40	W

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 8)	PD	225	mW
Thermal Resistance, Junction to Ambient Air (Note 8)	R _{ÐJA}	556	°C/W
Operating and Storage Temperature Range	TJ, T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

V_F = 0.9V max @ I_F = 10mA

Reve		Max Reverse		Breakdow	n Voltage	Max. Clamping Voltage V _C @ I _{PP} (Note 7)		Typical Temperature		
Type Number	Marking Code	V _{RWM}	Leakage I _R @ V _{RWM} (Note 9)	V _{BR} (Note 9) (V) @		@ I _T	Vc	I _{PP}	Coefficient	
		Volts	nA	Min	Nom	Max	mA	V	Α	T _c (%/°C)
MMBZ15VDL	KVJ	12.8	100	14.3	15	15.8	1.0	21.2	1.9	+0.080

V_F = 1.1V max @ I_F = 200mA

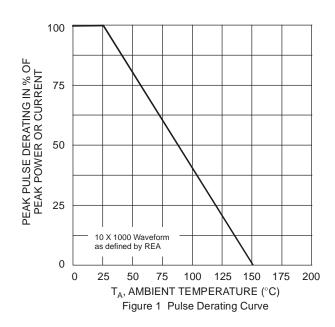
Туре	Marking		Max Reverse	Breakdown Voltage				Max. Clamping Voltage V _C @ I _{PP} (Note 7)		Typical Temperature
Number	Code	V _{RWM}	Leakage I _R @ V _{RWM} (Note 9)	V _{BR} (Note 9) (V)		@ I _T	Vc	I _{PP}	Coefficient	
		Volts	nA	Min	Nom	Max	mA	V	Α	T _c (%/°C)
MMBZ27VCL	KVP	22	50	25.65	27	28.35	1.0	38	1.0	+0.090

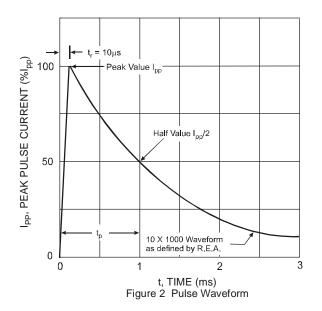
Notes:

7. Non-repetitive current pulse per Figure 2 and derate above $T_A = +25^{\circ}C$ per Figure 1.

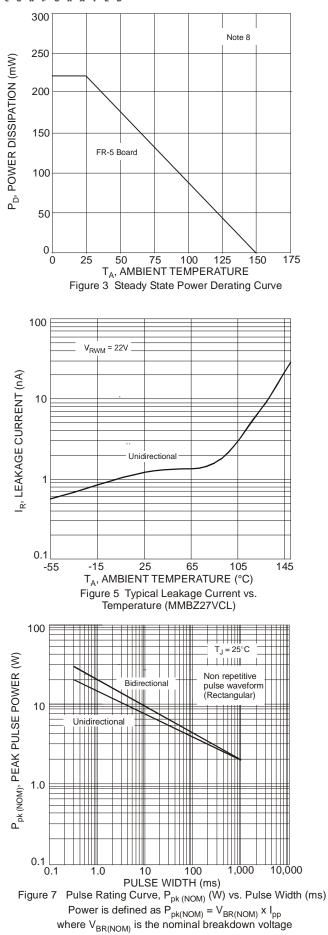
 Device mounted on FR-5 PCB 1.0 x 0.75 x 0.062 inch pad layout as shown on Diodes Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com. 200mW per element must not be exceeded.

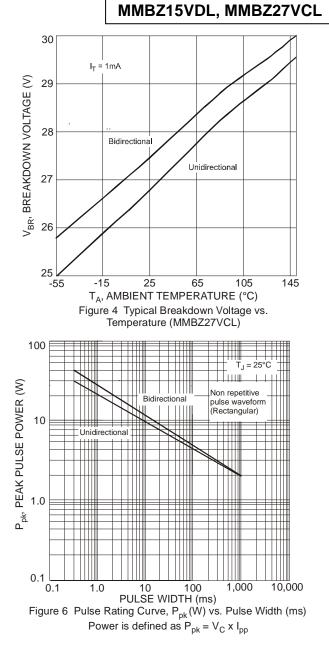
9. Short duration pulse test used to minimize self-heating effect.











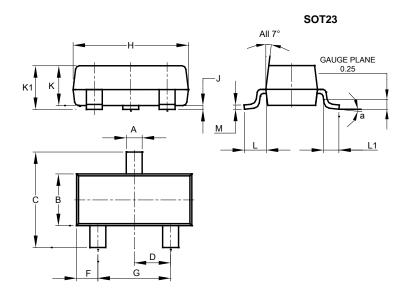
MMBZ15VDL, MMBZ27VCL

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Package Outline Dimensions

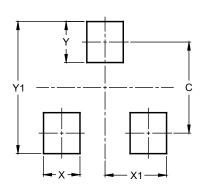
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
κ	0.890	1.00	0.975				
K1	0.903	1.10	1.025				
L	0.45	0.61	0.55				
L1	0.25	0.55	0.40				
М	0.085	0.150	0.110				
а	0°	8°	_				
All	All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23

Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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